



#### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
100V	110m $\Omega$ @10V	3A
	140m $\Omega$ @4.5V	

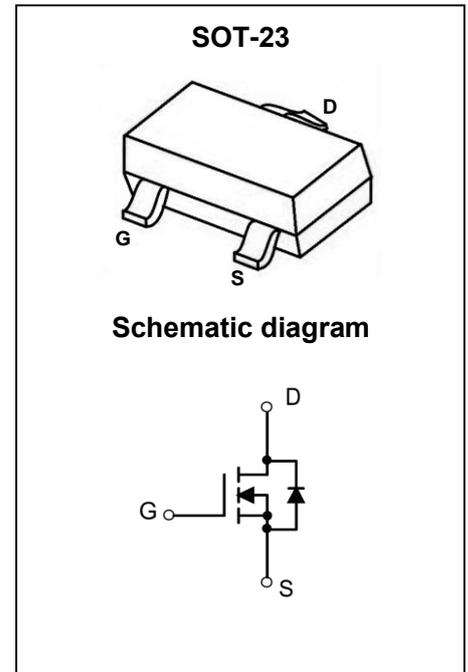
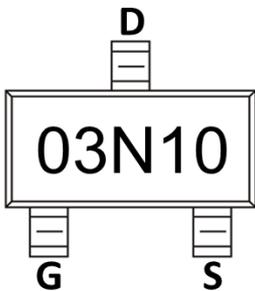
#### Feature

- Surface Mount Package
- High Density Cell Design for Extremely Low RDS(ON)
- Voltage Controlled Small Signal Switch
- Rugged and Reliable

#### Application

- Small Servo Motor Controls
- Power MOSFET Gate Drivers
- Switching Application

#### MARKING:



#### ABSOLUTE MAXIMUM RATINGS (Ta = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1,2</sup>	$I_D$	3	A
Pulsed Drain Current (tp=10 $\mu$ s)	$I_{DM}$	12	A
Power Dissipation	$P_D$	1.25	W
Thermal Resistance from Junction to Ambient <sup>1,2</sup>	$R_{\theta JA}$	100	$^{\circ}C/W$
Junction Temperature	$T_J$	150	$^{\circ}C$
Storage Temperature	$T_{STG}$	-55~ +150	$^{\circ}C$

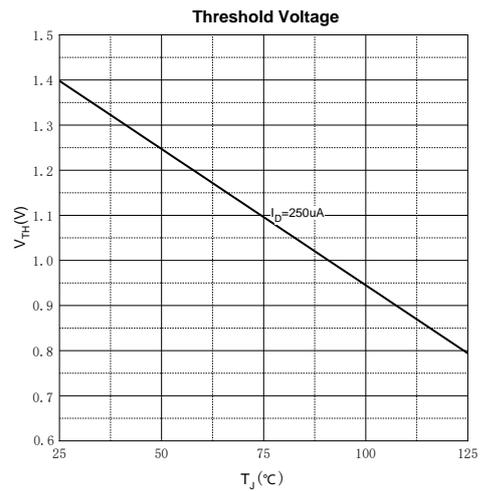
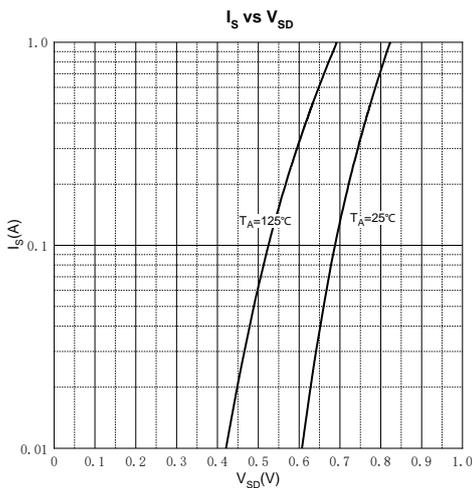
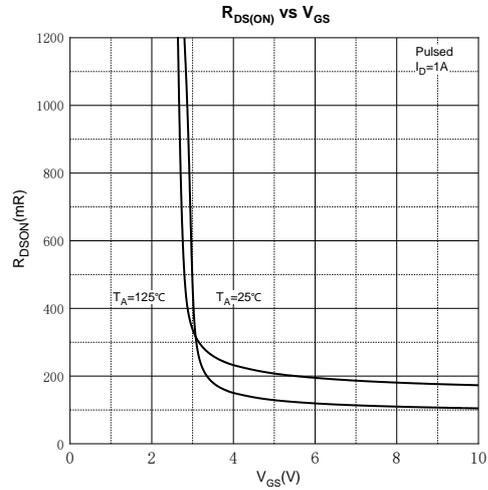
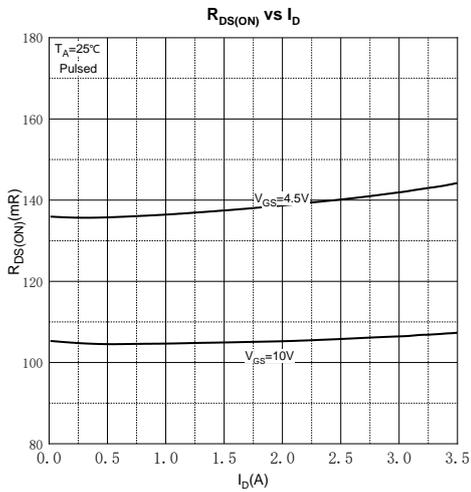
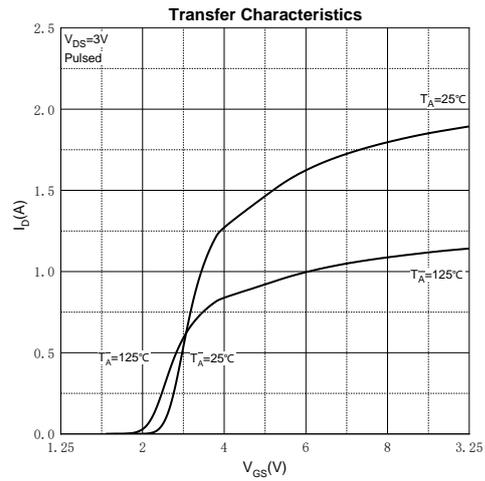
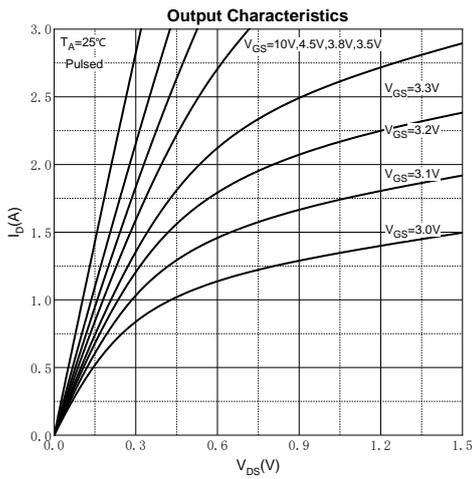
**MOSFET ELECTRICAL CHARACTERISTICS**( $T_a = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	100			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 80V, V_{GS} = 0V$			1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			$\pm 100$	nA
<b>On Characteristics<sup>3</sup></b>						
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1	1.5	3	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 1A$		110	140	m $\Omega$
		$V_{GS} = 4.5V, I_D = 1A$		140	190	
Forward tranconductance	$g_{FS}$	$V_{DS} = 5V, I_D = 3A$		5		S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 45V, V_{GS} = 0V, f = 1MHz$		142.4		pF
Output Capacitance	$C_{oss}$			56.18		
Reverse Transfer Capacitance	$C_{rss}$			4.45		
<b>Switching Characteristics</b>						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 50V, R_L = 19\Omega, R_G = 3\Omega$		6		ns
Turn-on rise time	$t_r$			4		
Turn-off delay time	$t_{d(off)}$			20		
Turn-off fall time	$t_f$			4		
Total Gate Charge	$Q_g$	$V_{DS} = 50V, I_D = 1A, V_{GS} = 10V$		3.29		nC
Gate-Source Charge	$Q_{gs}$			0.21		
Gate-Drain Charge	$Q_{gd}$			1.06		
<b>Diode Characteristics</b>						
Diode forward voltage <sup>3</sup>	$V_{SD}$	$I_S = 1A, V_{GS} = 0V$		0.8	1.2	V

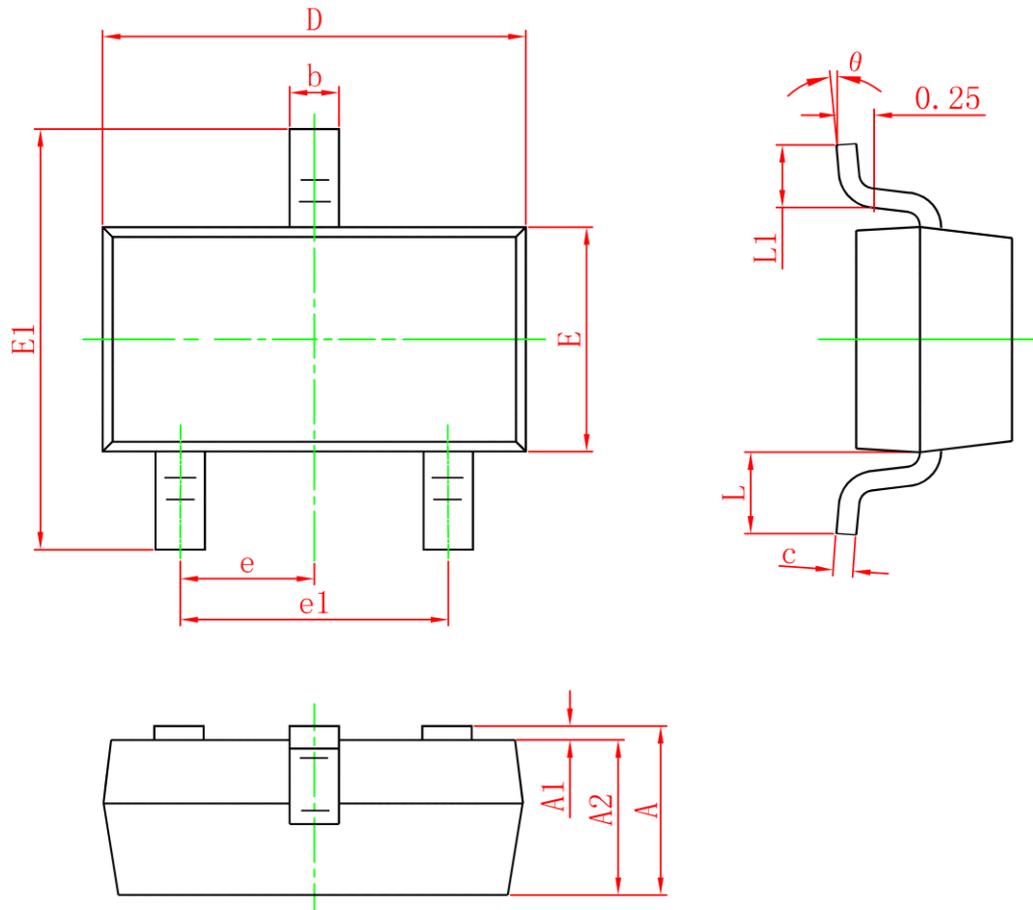
**Notes :**

- $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR4 board with 1 oz. single side copper, in a still air environment with  $T_a = 25^\circ\text{C}$ .
- $R_{\theta JA}$  is measured in the steady state
- Pulse test : Pulse width  $\leq 380\mu s$ , duty cycle  $\leq 2\%$ .

## Typical Characteristics



## SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0	0.100	0	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.150	1.500	0.045	0.059
E1	2.250	2.650	0.089	0.104
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°